

Test item list

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Test Configuration:

Num	Item	Spec
1.	Mounting Chassis:	FWS-2300
	1. PCB / CPU	FWB-7300 A1.0 (BIOS: 1.0) / Intel Pentium M 775 / 2.0GHz
	3. Memory	DSL DDR2-667 1GB / ELPIDA E5108AJBG-6E-E * 2
	4. 2.5" SATA HDD	Seagate ST9120823AS / 120GB
	5. Test Software	Windows XP / Run PassMark Burn In Test 5.3 Pro
2.	Power Supply	FSP130-5DD01
3.	Adapter	FSP FSP096-AHA
4.	System Fan	KDE 1204PKV1 * 2

Temperature rise test

Test Date: 02-09-2010

Test Product: FWS-2300

Test Site: AAEON QA Internal Lab.

Test Standard: Reference EN 61131-2(94), UL508 (94)

Temperature Measurement:

40 Channel Thermal Recorder:

YOKOGAWA Inc,

Model: DA100-13-1D

Date of Calibration: 12/08/09

Serial Number: 12A323190

Test Condition:

Ambient temperature: 40dC

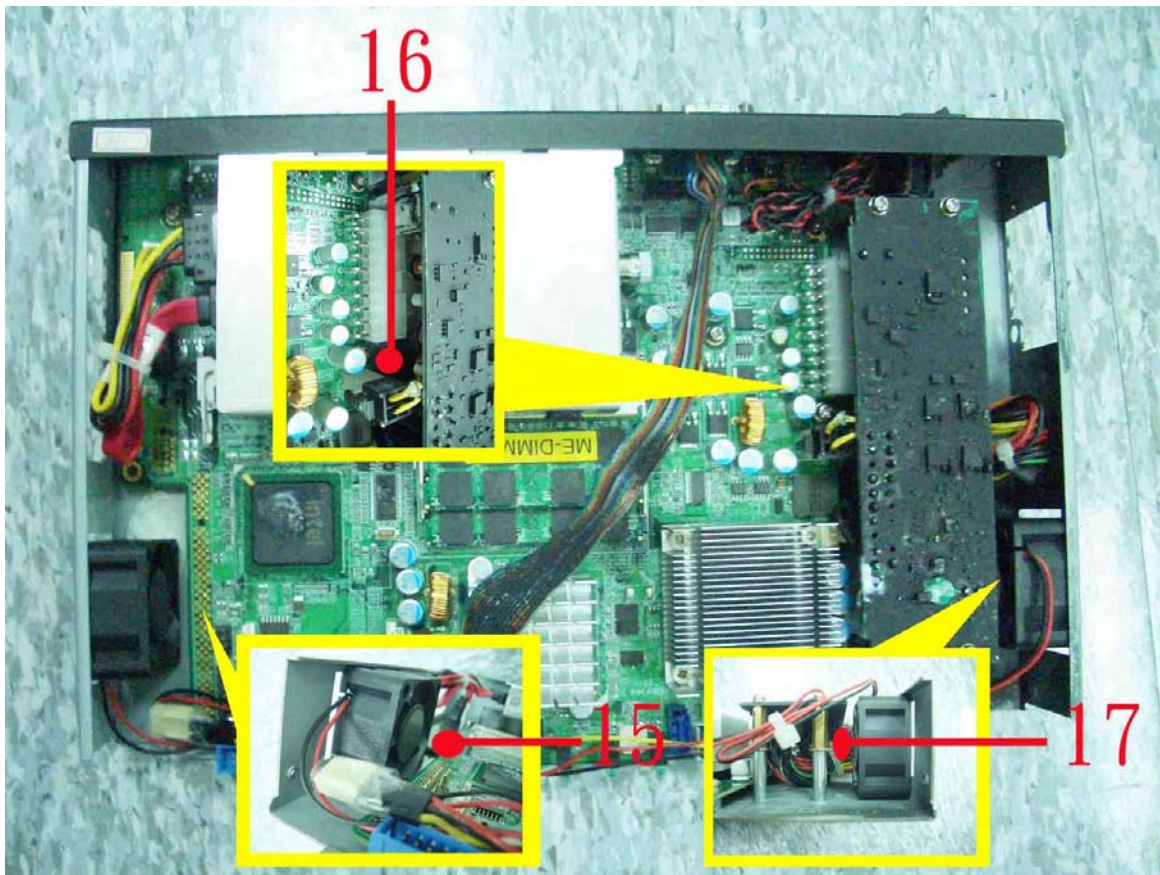
Continuous running till thermal stability (within less than 1°C)

Test Software:

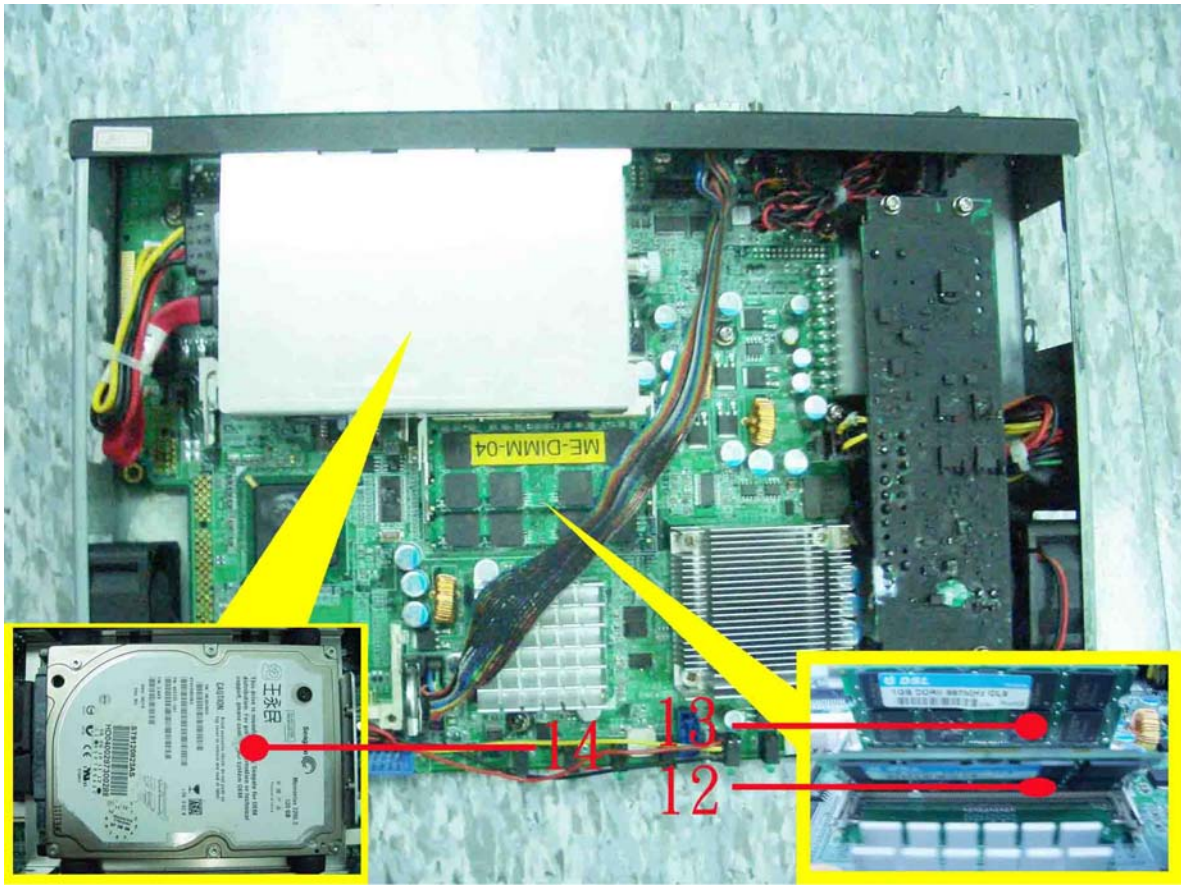
Windows XP / Run PassMark Burn In Test 5.3 Pro

Terminal Recorder:

Measuring Thermal Couple Position :



Temperature rise test



Temperature rise test

Thermal profile data:

FWS-2300

Point	Temp. Stage(°C)	Spec	40	25
1. CPU		100	82.9	67.9
2. U3 - (TF)Chipset Alviso 910GMLE.Intel.QG82910GMLE SLA9L		99	64.2	49.2
3. U8 - (TF)Chipset ICH6M.Intel.NH82801FBM SL89K B2		95	72.2	57.2
4. U21 - (TF)Power Controller.for Dual Channel DDR.Intersil.ISL6537CRZ		100	53.9	38.9
5. U18 - (TF)GigaBit Ethernet Chipset.INTEL.LU82541PI		95	55.2	40.2
6. U19 - (TF)GigaBit Ethernet Chipset.INTEL.LU82541PI		95	59.6	44.6
7.U22 - (TF)GigaBit Ethernet Chipset.INTEL.LU82541PI		95	59.1	44.1
8.U23 - (TF)GigaBit Ethernet Chipset.INTEL.LU82541PI		95	58.5	43.5
9. U20 - (TF)REG.SMD.TO-263 5A Linear Regulator.ATC.AP-1084KLA		125	52.5	37.5
10.U11 - (TF)CLOCK GENERATOR.ICS.ICS954206AGLFT		95	80.5	65.5
11.U13 - (TF)Clock Output Buffer.ICS.ICS9112M-16LF-T		95	82.1	67.1
12. Memory - 1		95	59.1	44.1
13. Memory - 2		95	57.2	42.2
14.HDD		60	53.5	38.5
15.Control Box Internal Air Temperature - 1		N/A	52.1	37.1
16.Power Supply - Ambient Temperature		N/A	42.6	27.6
17.Control Box Internal Air Temperature - 2		N/A	40.1	25.1

Any Tm value showed in red words which meaning the value over the Tc degree C of this device specification.

Temperature Measurement Table:

Location	T _A =49.7°C	Temp. Rise (Thermal Couple)	SpeedFan 4.31 (Read from BIOS)
CPU		82.9°C	66.0°C
System Temp. 1 (North Bridge)		64.2°C	64.0°C
System Temp. 2		N/A	58.0°C

Sample Configuration & Quantity Under Test:

Quantity: 1 (FWS-2300)

Test Result:

No problem was found during the temperature rise operation test.

Temperature cycle test

Test Date: 02-06~08-2010

Test Product: FWS-2300

Test Site: AAEON QA Internal Lab.

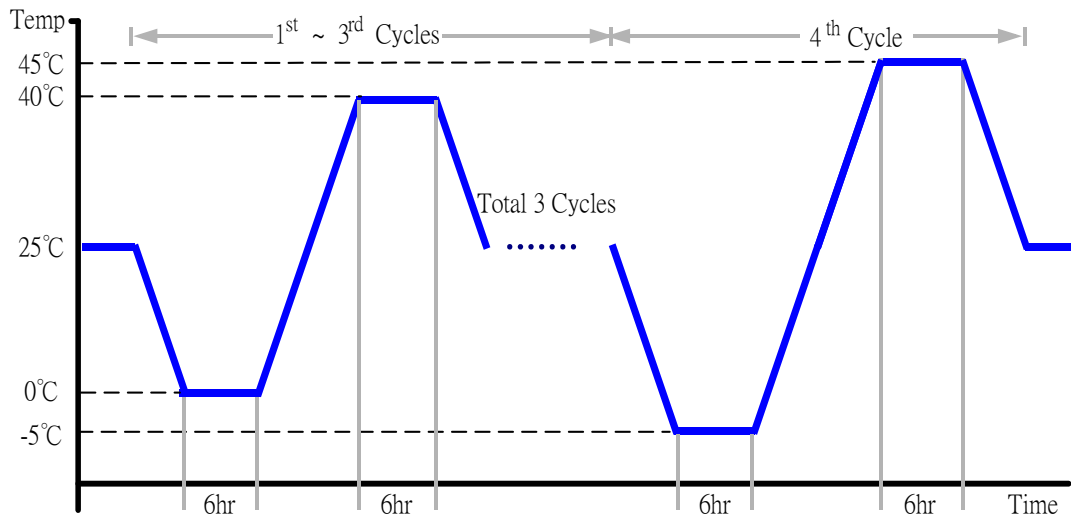
Test Standard: Reference IEC68-2-14 Testing procedures
Test N: Change of temperature Test

Test Equipment:

Programmable Temperature & Humidity Chamber
K.SON. INS. TECH. CORP.
Model: THS-A4C-100
Date of Calibration: 06/17/09
Serial Number: 3188

Test Condition:

1. Test Low Temperature: 0°C (1~3 cycles)
-5°C (4th cycle)
2. Test High Temperature: 40°C (1~3 cycles)
45°C (4th cycle)
3. Test dwell time: 6Hrs
4. Temperature slope: 2°C/min
5. Test cycle: 4 cycles
6. Test Environment Curve:



Sample Configuration & Quantity Under Test:

Quantity: 1 (FWS-2300)

Test Result:

No problem was found during the temperature operation cycle test.

Test Date: 01-27~29-2010

Test Product: FWS-2300

Test Site: AAEON QA Internal Lab.

Test Standard: Reference IEC 68-2-2 Testing procedures
Test Bb: Dry Heat Test (Non-operation)

Test Equipment:

Programmable Temperature & Humidity Chamber
K.SON. INS. TECH. CORP.

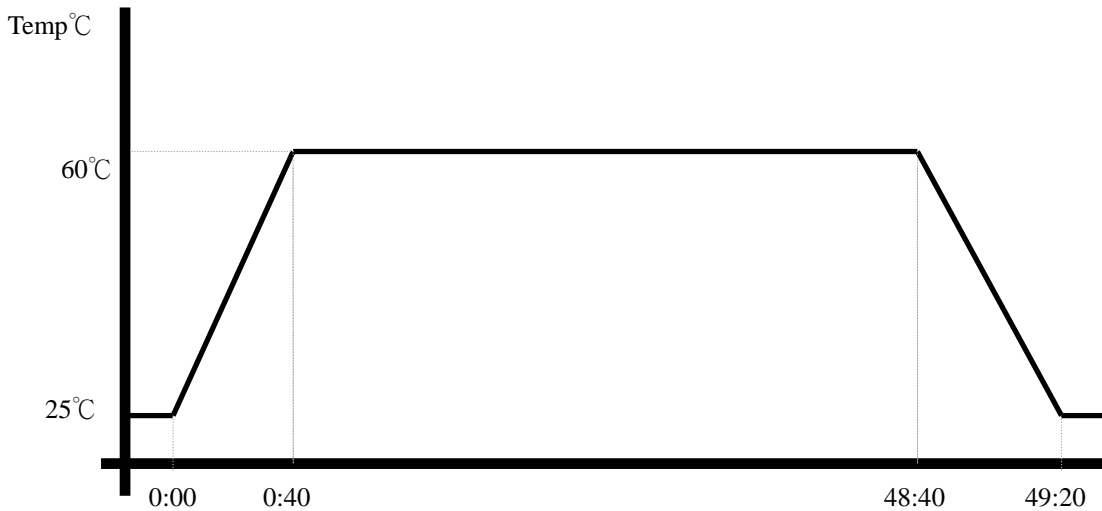
Model: THS-A4C-100

Date of Calibration: 06/17/09

Serial Number: 3188

Testing Item:

1. Test Temperature: 60°C
2. Test Times: 48Hrs
3. Test Software: Windows XP / Run PassMark Burn In Test 5.3 Pro
4. Test Environment Curve:



Sample Configuration & Quantity Under Test:

Quantity: 1 (FWS-2300)

Test Result:

No problem was found after the high temperature storage test.

Test Date: 02-01~03-2010

Test Product: FWS-2300

Test Site: AAEON QA Internal Lab.

Test Standard: Reference IEC 68-2-1 Testing procedures
Test Ab: Cold Test (Non-operation)

Test Equipment:

Programmable Temperature & Humidity Chamber
K.SON. INS. TECH. CORP.

Model: THS-A4C-100

Date of Calibration: 06/17/09

Serial Number: 3188

Testing Item:

1. Test Temperature: -20°C
2. Test Times: 48Hrs
3. Test Software: Windows XP / Run PassMark Burn In Test 5.3 Pro
4. Test Environment Curve:



Sample Configuration & Quantity Under Test:

Quantity: 1 (FWS-2300)

Test Result:

No problem was found after the low temperature storage test.

Test Date: 01-29~31-2010

Test Product: FWS-2300

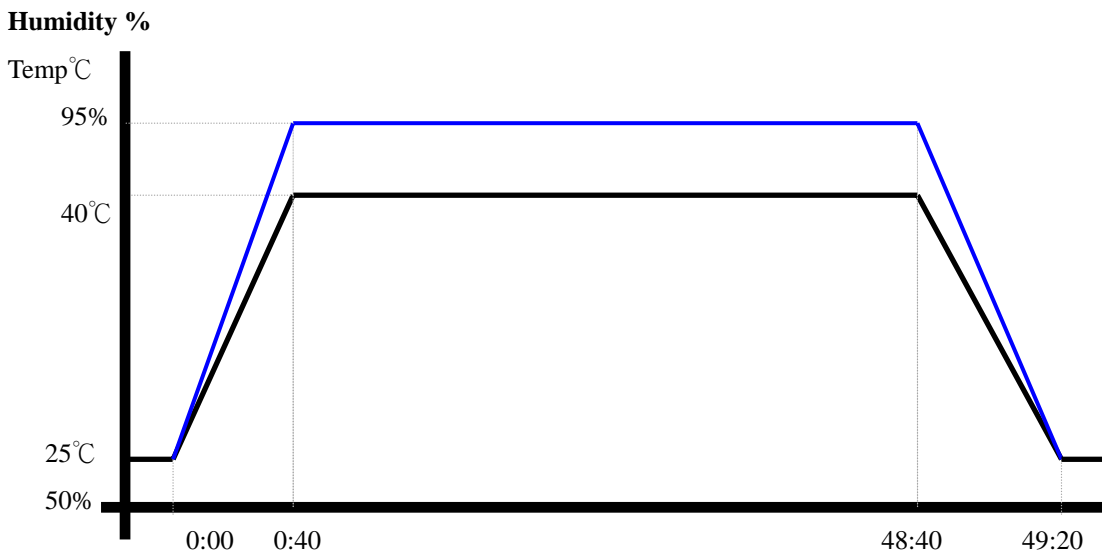
Test Site: AAEON QA Internal Lab.

Test Standard: Reference IEC 68-2-3 Testing procedures
Test Ca: Damp heat, steady state (Non-operation)

Test Equipment:
Programmable Temperature & Humidity Chamber
K.SON. INS. TECH. CORP.
Model: THS-A4C-100
Date of Calibration: 06/17/09
Serial Number: 3188

Testing Item:

1. Test Temperature: 40°C
2. Test Humidity: 95%RH
3. Test Times: 48Hrs
4. Test Software: Windows XP / Run PassMark Burn In Test 5.3 Pro
5. Test Environment Curve:



Sample Configuration & Quantity Under Test:

Quantity: 1 (FWS-2300)

Test Result:

No problem was found after the humidity storage test.

Cold start and hot start test

Test Date: 02-04~05-2010

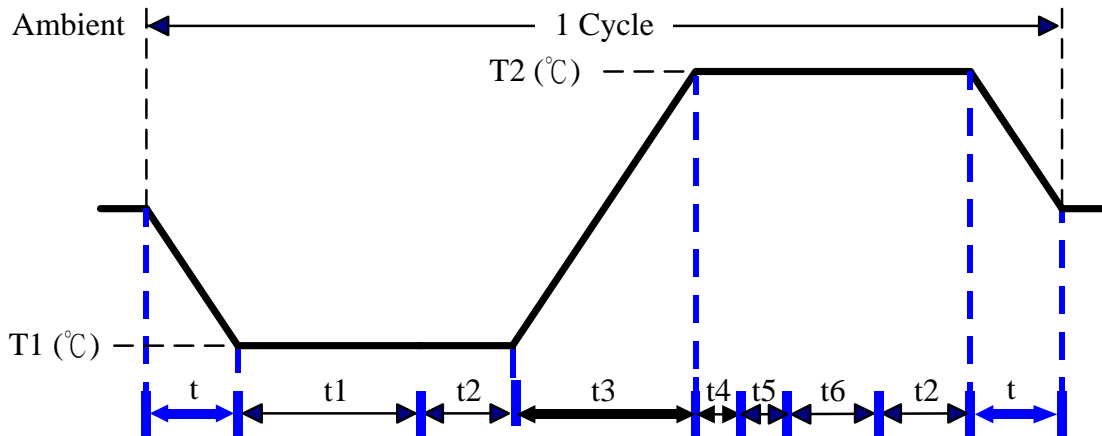
Test Product: FWS-2300

Test Site: AAEON QA Internal Lab.

Test Standard: Reference IEC 68-2-14 Testing procedures
Test N: Change of temperature Test

Test Equipment:
Programmable Temperature & Humidity Chamber
K.SON. INS. TECH. CORP.
Model: THS-A4C-100
Date of Calibration: 06/17/09
Serial Number: 3188

Test Condition:



Parameters	Description
T1	-5°C
T2	45°C
t1	4 hrs
t2, t6	2 hrs
t4, t5	1 hrs
t, t3	2°C/min
n (Cycle)	1

t = temprature slope
t, t1, t6: Power Off
t2: Power on/off test 10 times (on 2 min / off 5min)
t3, t4: Run PassMark Burn In Test
t5: Win XP Software restart test 3 times
Test Software:Windows XP

Test Result:

- a. No problem was found during the cold start test.
- b. No problem was found during the hot start test.